Unit: mm

TOSHIBA Field-Effect Transistor Silicon N / P Channel MOS Type

SSM6L36FE

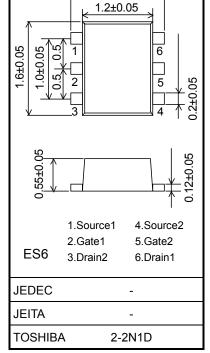
○ High-Speed Switching Applications

• 1.5-V drive

٠	Low ON-resistance Q1 Nch:	$R_{on} = 1.52\Omega \text{ (max)} (@V_{GS} = 1.5 \text{ V})$
		R_{on} = 1.14 Ω (max) (@V _{GS} = 1.8 V)
		$R_{on} = 0.85\Omega \text{ (max)} (@V_{GS} = 2.5 \text{ V})$
		$R_{on} = 0.66\Omega \text{ (max)} (@V_{GS} = 4.5 \text{ V})$
		R _{on} = 0.63Ω (max) (@V _{GS} = 5.0 V)
٠	Q2 Pch:	$R_{on} = 3.60\Omega \text{ (max)} (@V_{GS} = -1.5 \text{ V})$
		$R_{on} = 2.70\Omega \text{ (max)} (@V_{GS} = -1.8 \text{ V})$
		R _{on} = 1.60Ω (max) (@V _{GS} = -2.8 V)
		$R_{on} = 1.31\Omega \text{ (max)} (@V_{GS} = -4.5 \text{ V})$

Q1 Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Drain-source voltage	V _{DSS}	20	V	
Gate-source voltage	V _{GSS}	±10	V	
Drain current	DC	I _D	500	mA
Diam current	Pulse	I _{DP}	1000	IIIA



1.6±0.05

Weight: 3.0 mg (typ.)

Q2 Absolute Maximum Ratings (Ta = 25°C)

Characteristics	;	Symbol	Rating	Unit
Drain-source voltage	V _{DSS}	-20	V	
Gate-source voltage	V _{GSS}	±8	V	
Drain current	DC	۱ _D	-330	mA
	Pulse	I _{DP}	-660	ША

Absolute Maximum Ratings (Ta = 25 °C) (Common to the Q1, Q2)

Characteristics	Symbol	Rating	Unit	
Drain power dissipation	P _D (Note 1)	150	mW	
Channel temperature	T _{ch}	150	°C	
Storage temperature range	T _{stg}	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Total rating

Mounted on an FR4 board

(25.4 mm \times 25.4 mm \times 1.6 mm, Cu Pad: 0.135 mm² \times 6)

Start of commercial production 2008-06

Q1 Electrical Characteristics (Ta = 25°C)

Characte	eristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Drain-source breakdown voltage		V (BR) DSS	$I_{D} = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	20 —		_	V	
Drain-source break	kuown voltage	V (BR) DSX	I _D = 1 mA, V _{GS} = - 10 V		12	—	_	v
Drain cutoff curren	t	I _{DSS}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		_	_	1	μA
Gate leakage curre	ent	I _{GSS}	$V_{GS}=\pm 10~V,~V_{DS}=0~V$		_	_	±1	μA
Gate threshold vol	tage	V _{th}	$V_{DS} = 3 V, I_D = 1 mA$		0.35	—	1.0	V
Forward transfer a	dmittance	Y _{fs}	$V_{DS} = 3 V, I_D = 200 mA$	(Note2)	420	840	_	mS
			$I_D = 200 \text{ mA}, V_{GS} = 5.0 \text{ V}$	(Note2)	_	0.46	0.63	
			$I_D = 200 \text{ mA}, V_{GS} = 4.5 \text{ V}$	(Note2)	_	0.51	0.66	
Drain-source ON-resistance		R _{DS (ON)}	I_{D} = 200 mA, V_{GS} = 2.5 V	(Note2)	_	0.66	0.85	Ω
			I _D = 100 mA, V _{GS} = 1.8 V	(Note2)		0.81	1.14	
			I _D = 50 mA, V _{GS} = 1.5 V	(Note2)		0.95	1.52	
Input capacitance		C _{iss}				46	_	
Output capacitance	e	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		_	10.8		pF
Reverse transfer capacitance		C _{rss}				7.3	_	1
Total Gate Charge		Qg			_	1.23	_	
Gate-Source Charge		Q _{gs}	V _{DS} = 10 V, I _D = 0.5 A, V _{GS} = 4.0 V		_	0.60	_	nC
Gate-Drain Charge		Q _{gd}				0.63		
Switching time	Turn-on time	t _{on}	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 200 \text{ mA}$		_	30	—	
	Turn-off time	t _{off}	V_{GS} = 0 to 2.5 V, R_{G} = 50 Ω		_	75	_	ns
Drain-source forward voltage		V _{DSF}	$I_D = -0.5 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	(Note2)	_	-0.88	-1.2	V

Q2 Electrical Characteristics (Ta = 25°C)

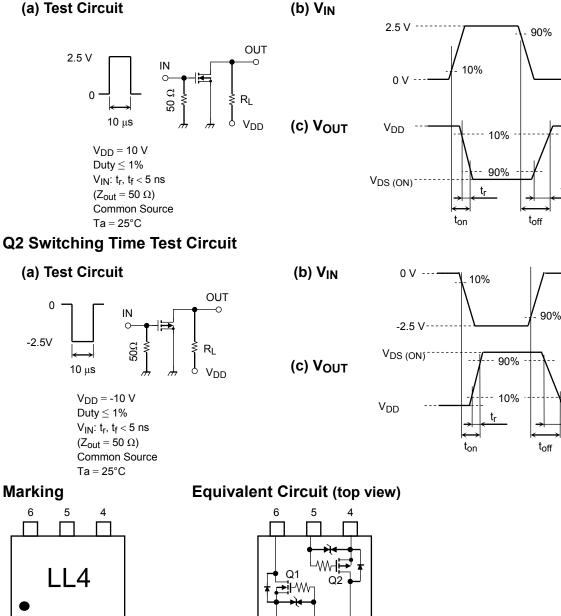
Characte	ristics	Symbol	Test Conditions	Min	Тур.	Max	Unit	
Drain-source breakdown voltage		V (BR) DSS	$I_{D} = -1 \text{ mA}, V_{GS} = 0 \text{ V}$	-20	—	—	V	
Drain-source break	down voltage	V (BR) DSX	I _D = -1 mA, V _{GS} = 8 V	-12	—	—	v	
Drain cutoff current	t	IDSS	$V_{DS} = -16 V, V_{GS} = 0 V$	—	_	-10	μA	
Gate leakage curre	ent	I _{GSS}	$V_{GS} = \pm 8 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	—	_	±1	μA	
Gate threshold volt	age	V _{th}	$V_{DS} = -3 V, I_D = -1 mA$	-0.3	_	-1.0	V	
Forward transfer ad	dmittance	Y _{fs}	$V_{DS} = -3 V, I_D = -100 mA$ (Note2)	190	_	_	mS	
			$I_D = -100 \text{ mA}, V_{GS} = -4.5 \text{ V}$ (Note2)	_	0.95	1.31		
			$I_D = -80 \text{ mA}, V_{GS} = -2.8 \text{ V}$ (Note2)	_	1.22	1.60		
Drain-source ON-resistance		R _{DS (ON)}	$I_D = -40 \text{ mA}, V_{GS} = -1.8 \text{ V}$ (Note2)	_	1.80	2.70	Ω	
			$I_D = -30 \text{ mA}, V_{GS} = -1.5 \text{ V}$ (Note2)	—	2.23	3.60		
Input capacitance		C _{iss}		—	43			
Output capacitance		C _{oss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	10.3		pF	
Reverse transfer capacitance		C _{rss}		_	6.1			
Total Gate Charge		Qg		-	1.2	_		
Gate-Source Charge		Q _{gs}	V _{DS} = -10 V, I _{DS} = -330mA, V _{GS} = -4 V	_	0.85	_	nC	
Gate-Drain Charge		Q _{gd}		_	0.35			
Switching time	Turn-on time	t _{on}	V_{DD} = -10 V, I _D = -100 mA V _{GS} = 0 to -2.5 V, R _G = 50 Ω	—	90	_		
	Turn-off time	t _{off}		_	200	_	ns	
Drain-source forward voltage		V _{DSF}	$I_D = 330 \text{ mA}, V_{GS} = 0 \text{ V}$ (Note2)	_	0.88	1.2	V	

Note 2: Pulse test

tf

Q1 Switching Time Test Circuit

(a) Test Circuit



2 3 Q1 Usage Considerations

6

Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to below (1 mA for the Q1 of the SSM6L36FE). Then, for normal switching operation, V_{GS(on)} must be higher than V_{th}, and V_{GS(off)} must be lower than V_{th.} This relationship can be expressed as: V_{GS(off)} < V_{th} < V_{GS(on)}.

2

3

Take this into consideration when using the device.

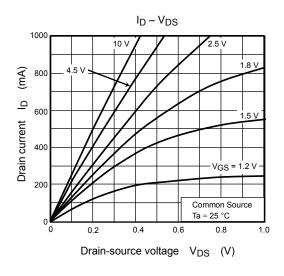
Q2 Usage Considerations

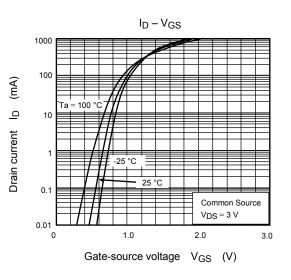
Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to below (-1 mA for the Q2 of the SSM6L36FE). Then, for normal switching operation, $V_{GS(on)}$ must be higher than V_{th_1} and $V_{GS(off)}$ must be lower than V_{th} . This relationship can be expressed as: $V_{GS(off)} < V_{th} < V_{GS(on)}$. Take this into consideration when using the device.

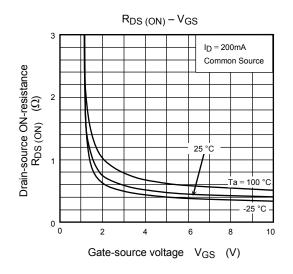
Handling Precaution

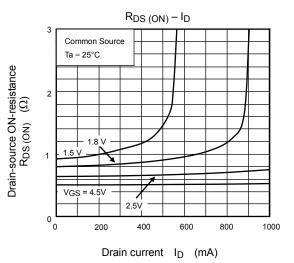
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

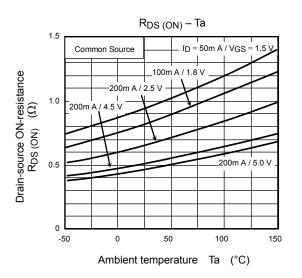
Q1 (N-ch MOSFET)

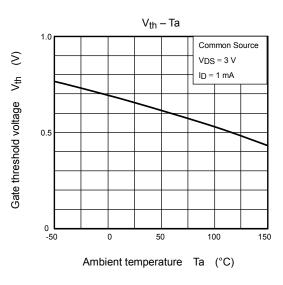




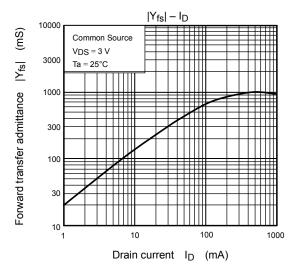


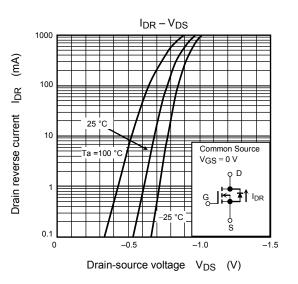


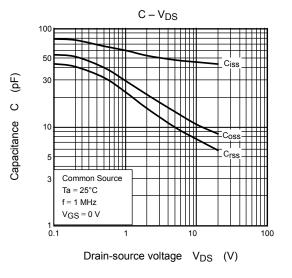


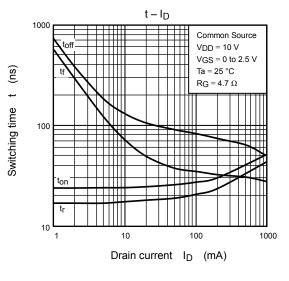


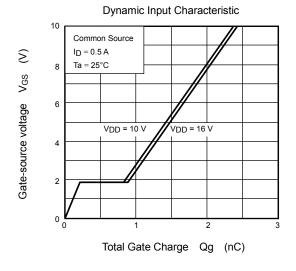
Q1 (N-ch MOSFET)



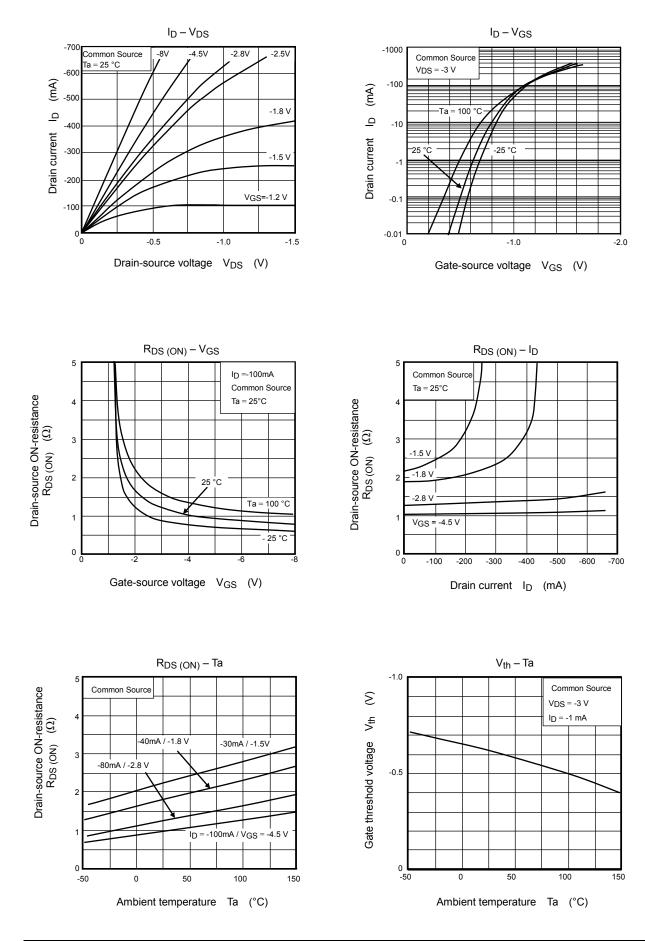






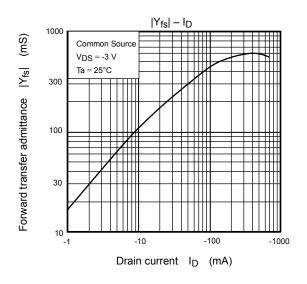


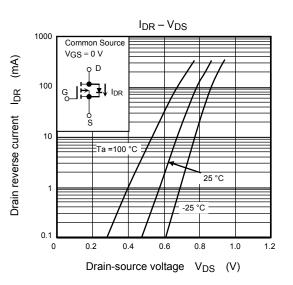
Q2 (P-ch MOSFET)

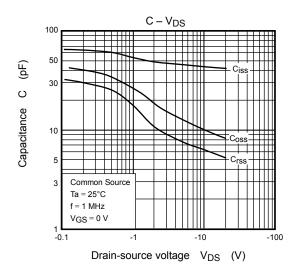


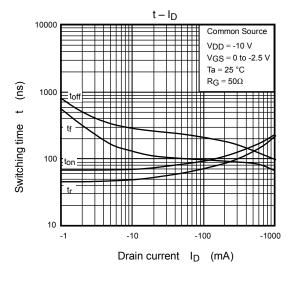
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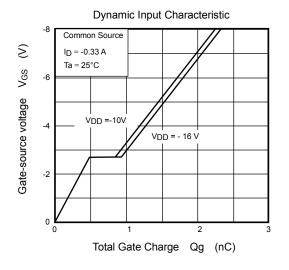
Q2 (P-ch MOSFET)



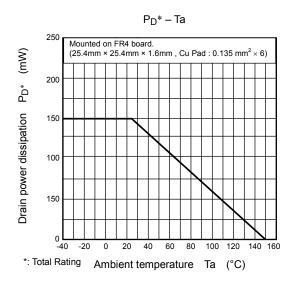








Q1, Q2 Common



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